

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3920459

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHOA-SIONG RAYMOND LIM	10/19/2012
HWEE-SENG JIMMY CHEW	10/19/2012
RECEIVING PARTY DATA	
Name:	ADVANPACK SOLUTIONS PTE LTD.
Street Address:	BLK 21 KALLANG AVENUE #02-167
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	339412
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15183761
CORRESPONDENCE DATA	
Fax Number:	(202)408-0924
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-371-8976
Email:	firm@rabinberdo.com
Correspondent Name:	RABIN & BERDO, P.C.
Address Line 1:	1101 14TH ST., N.W., SUITE 500
Address Line 4:	WASHINGTON, D.C. 20005
ATTORNEY DOCKET NUMBER:	SUND-1458D1
NAME OF SUBMITTER:	STEVEN M. RABIN
SIGNATURE:	/Steven M. Rabin/
DATE SIGNED:	06/15/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	
source=03_SUND-1458D1-Asg_dec_from_parent#page1.tif	
source=03_SUND-1458D1-Asg_dec_from_parent#page2.tif	

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Shoa-Siong Raymond Lim and Hwee-Seng Jimmy Chew

hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

PACKAGE CARRIER, PACKAGE CARRIER MANUFACTURING METHOD, PACKAGE STRUCTURE FOR SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

☒ [X] said application being attached hereto;

☐ [] said application having been filed in the United States Patent and Trademark Office on

_____, as Application Serial No. _____, and was amended

on _____ (If applicable);

☐ [] the specification of which was filed under the Patent Cooperation Treaty on _____,

Serial No. _____, the United States of America being designated.

AND WHEREAS ADVANPACK SOLUTIONS PTE LTD., hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Address all correspondence and telephone calls to Rabin & Berdo, P.C., 1101 14th Street, N.W., Suite 500, Washington, D.C. 20005, Telephone: (202) 371-8976; Fax: (202) 408-0924, Customer No. 23995.

WITNESS:

Signature: Huifan

Name: Huang Yan

Address: Blk 21 Kallang Avenue
#02-167 Singapore 339412

WITNESS:

Signature: Grace Chen

Name: Grace Chen

Address: Blk 21 Kallang Avenue
#02-167 Singapore 339412

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: [Signature]

Legal Name: Shoa-Siong Raymond Lim

Date: 19-Oct-2012

ASSIGNOR (SECOND INVENTOR):

Signature: [Signature]

Legal Name: Hwee-Seng Jimmy Chew

Date: 19-Oct-2012